INSTRUCTIONS:

- 1. Read the Access to Intellectual Property & Non-Disclosure Agreement.
- 2. Fill in required fields (name, city, and signatory and witness information). Print all information legibly.
- 3. Sign the agreement. Original ("wet") signatures or secure electronic are required.
- 4. Email signed form to Sarah Neville (<u>Sarah.Neville@cmc.ca</u>). Note: A high resolution photograph of the signed agreement is acceptable.

2020 PASSIVE SILICON PHOTONICS FABRICATION COURSE (ON-LINE) ACCESS TO INTELLECTUAL PROPERTY & NON-DISCLOSURE AGREEMENT

1		of the City/Town of
(Course Partic	cipant Full Name, Print)	_
		acknowledge and agree that:
	(City/Town, Print)	
offered through CANADIA CMC MICROSYSTEMS (h facility, electronic content non-public intellectual prope Information"), including Corparties which CMC has per	erein called " CMC ") I may or and/or fabricated multi-pro rty and confidential and propinfidential Information of CMC, (DRPORATION operating as have access to a laboratory, oject wafer chips containing rietary information ("Confidential Confidential Information of third participants, and Confidential
undertake that I will not at this ordered so to do by law or co	ourt process. If I am required to di provide CMC with prompt written	ential Information, I declare and any Confidential Information unless sclose Confidential Information by notice to enable CMC to seek a
	ind course material, and to delete any and all paper and	d electronic copies of Confidential
Information obtained through my association with CMC from any and all systems where they would be stored (including any hard drives, memory sticks or backup storage devices) upon the earlier of: (i) a written request by CMC, or (ii) the end of my association with CMC.		
Course Participant:		
Signature:		
Name:		
Title:		
Institution / Company Name:		
Address:		
-		
Date:		